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On-Chip Photonics

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Deadline for manuscript submissions: closed (20 April 2024)

Message from the Guest Editor

The on-chip photonics industry has been growing rapidly thanks to the maturity level that chip foundries have reached in fabricating such chips with industrial-level accuracy and mass production.

In this Special Issue, we invite authors from various fields to present their recent findings in the area of on-chip photonics applications. Areas of interest may include but are not limited to:

- 1. Co Packaged Optics for telecommunications and optical transceivers;
- 2. Design of novel photonic devices and systems for telecommunication applications;
- 3. Novel software and modeling tools for photonic devices and systems;
- 4. Latest industrial applications and challenges;
- 5. Applications of metasurfaces in industrial applications;
- 6. Recent advances in materials for photonic devices;
- 7. Novel characterization and fabrication methodologies, techniques, and industrial systems;
- 8. Novel devices and systems for sensing applications;
- 9. Machine learning and artificial intelligence applications for photonic devices.

We look forward to receiving your submissions and publishing a high-quality Special Issue that showcases the latest advances in on-chip photonics.





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